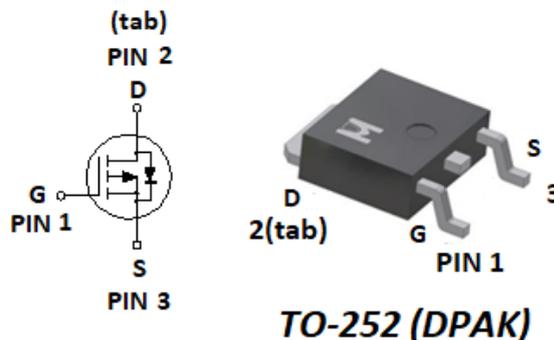


Single P-Channel Logic Level Enhancement Mode Field Effect Transistor

• Product Summary:

	P-CH
$BV_{DSS}$	-60V
$R_{DS(ON)(MAX.)}@V_{GS}=-10V$	18m $\Omega$
$R_{DS(ON)(MAX.)}@V_{GS}=-4.5V$	22m $\Omega$
$I_D @T_C=25^\circ C$	-50A

• Pin Description:



Single P Channel MOSFET

UIS, Rg 100% Tested

RoHS & Halogen Free & TSCA Compliant



• ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ C$  Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>1</sup>	$T_C = 25^\circ C$	$I_D$	-50	A
	$T_C = 100^\circ C$		-32	
	$T_A = 25^\circ C$		-8	
	$T_A = 70^\circ C$		-6	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	-92	
Avalanche Current <sup>1</sup>		$I_{AS}$	-58	
Avalanche Energy <sup>1</sup>	L = 0.1mH	$E_{AS}$	168	mJ
Repetitive Avalanche Energy <sup>2</sup>	L = 0.05mH	$E_{AR}$	84.1	
Power Dissipation <sup>1</sup>	$T_C = 25^\circ C$	$P_D$	92.6	W
	$T_C = 100^\circ C$		37	
Power Dissipation <sup>1</sup>	$T_A = 25^\circ C$		2.7	W
	$T_A = 70^\circ C$		1.7	
Operating Junction & Storage Temperature Range		$T_j, T_{stg}$	-55 to 150	$^\circ C$

<sup>1</sup> 100% UIS testing in condition of  $V_D=-30V$ ,  $L=0.1mH$ ,  $V_G=10V$ ,  $I_L=35A$ , Rated  $V_{DS}=-60V$  P-CH

• THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case		$R_{\theta JC}$		1.35	$^\circ C / W$
Junction-to-Ambient <sup>3</sup>	$t \leq 10s$	$R_{\theta JA}$		14	
	Steady-State	$R_{\theta JA}$		46	

<sup>1</sup> Pulse width limited by maximum junction temperature.

<sup>2</sup> Duty cycle < 1%

<sup>3</sup> The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ C$ .

<sup>4</sup> Guarantee by Engineering test

▪ ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-60			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-1.2	-1.6	-2.5	
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -60V, V <sub>GS</sub> = 0V			-1	μA
		V <sub>DS</sub> = -60V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 125 °C			-25	
On-State Drain Current <sup>1</sup>	I <sub>D(ON)</sub>	V <sub>DS</sub> = -5V, V <sub>GS</sub> = -10V	-50			A
Drain-Source On-State Resistance <sup>1</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> = -10V, I <sub>D</sub> = -20A		15	18	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -10A		18	22	
Forward Transconductance <sup>1</sup>	g <sub>fs</sub>	V <sub>DS</sub> = -5V, I <sub>D</sub> = -20A		71		S
<b>DYNAMIC</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = -30V, f = 1MHz		5494		pF
Output Capacitance	C <sub>oss</sub>			251		
Reverse Transfer Capacitance	C <sub>rss</sub>			151		
Gate Resistance	R <sub>g</sub>	f = 1MHz		1.9		Ω
Total Gate Charge <sup>1,2</sup>	Q <sub>g</sub> (V <sub>GS</sub> =10V)	V <sub>DS</sub> = -30V, V <sub>GS</sub> = -10V, I <sub>D</sub> = -20A		115		nC
	Q <sub>g</sub> (V <sub>GS</sub> =4.5V)			52		
Gate-Source Charge <sup>1,2</sup>	Q <sub>gs</sub>			18		
Gate-Drain Charge <sup>1,2</sup>	Q <sub>gd</sub>			18		
Turn-On Delay Time <sup>1,2</sup>	t <sub>d(on)</sub>		V <sub>DS</sub> = -30V, V <sub>GS</sub> = -10V, I <sub>D</sub> = -5A, R <sub>g</sub> = 3Ω		10	
Rise Time <sup>1,2</sup>	t <sub>r</sub>			11		
Turn-Off Delay Time <sup>1,2</sup>	t <sub>d(off)</sub>			121		
Fall Time <sup>1,2</sup>	t <sub>f</sub>			41		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Continuous Current	I <sub>S</sub>				-50	A
Pulsed Current <sup>3</sup>	I <sub>SM</sub>				-92	
Forward Voltage <sup>1</sup>	V <sub>SD</sub>	I <sub>F</sub> = I <sub>S</sub> , V <sub>GS</sub> = 0V			-1.2	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = I <sub>S</sub> , dI <sub>F</sub> /dt = 100A / μS		24.1		nS
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>			2.31		A
Reverse Recovery Charge	Q <sub>rr</sub>				27.9	

<sup>1</sup>Pulse test : Pulse Width ≤ 300 usec, Duty Cycle ≤ 2%.

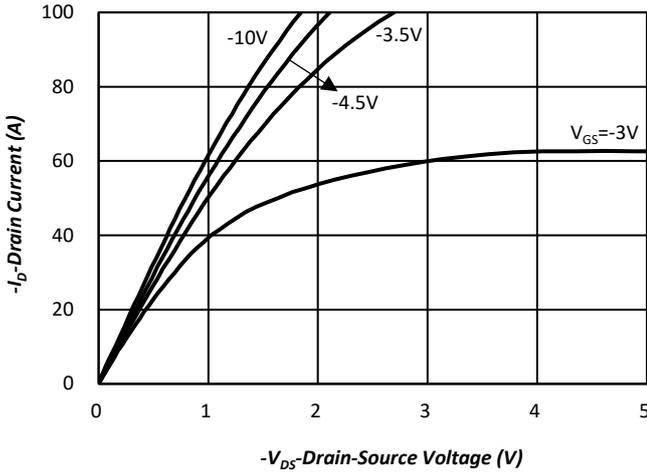
<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Pulse width limited by maximum junction temperature.

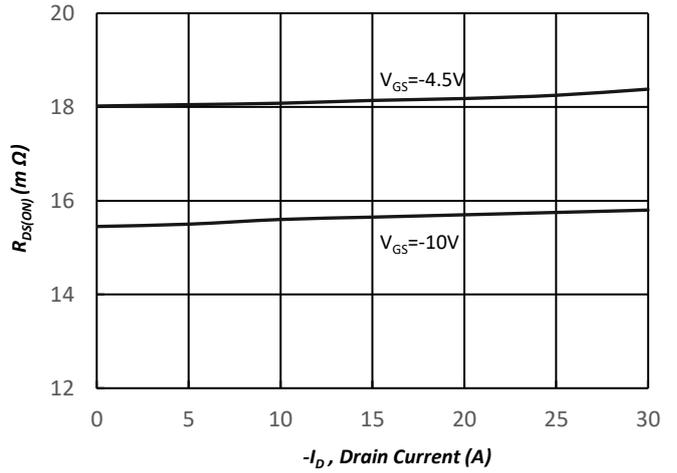
<sup>4</sup>Guarantee by FT test Item

<sup>5</sup>Guarantee by Engineering test

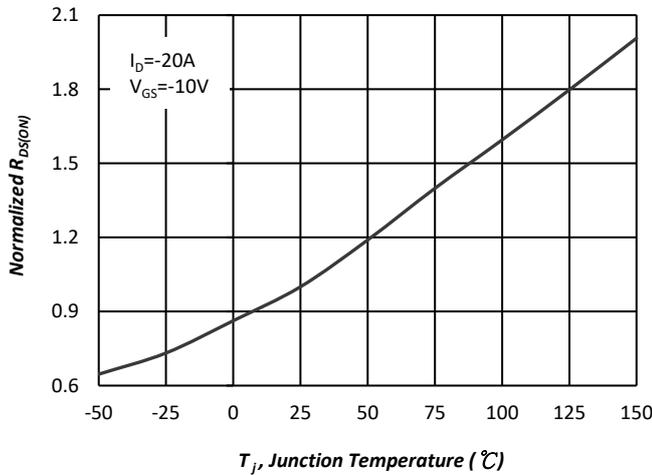
**▪ TYPICAL CHARACTERISTICS**



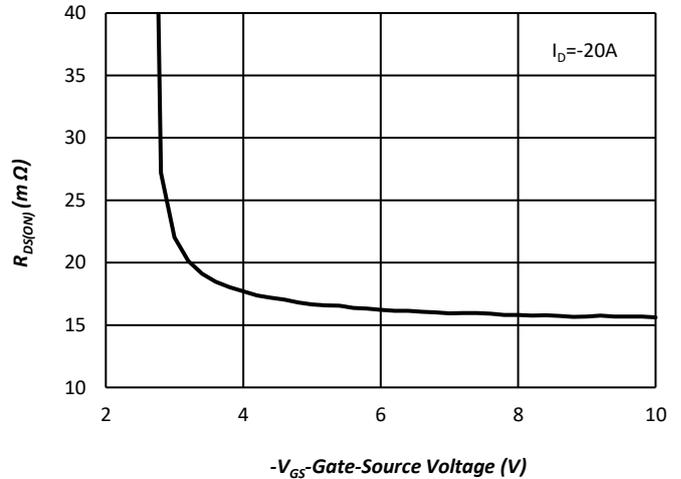
**Fig.1 Typical Output Characteristics**



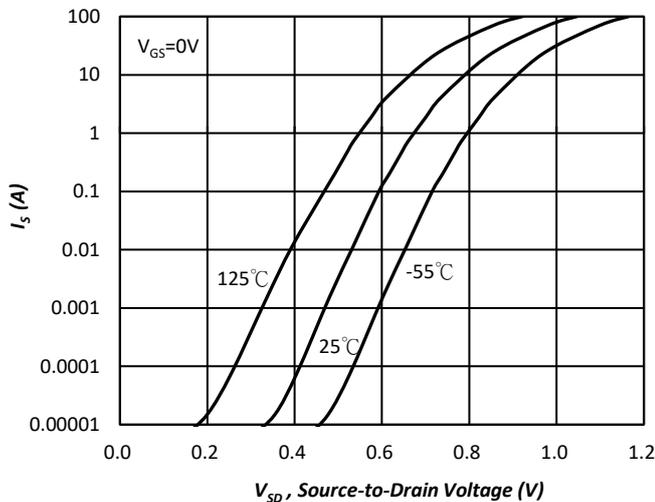
**Fig.2 On-Resistance Variation with Drain Current and Gate Voltage**



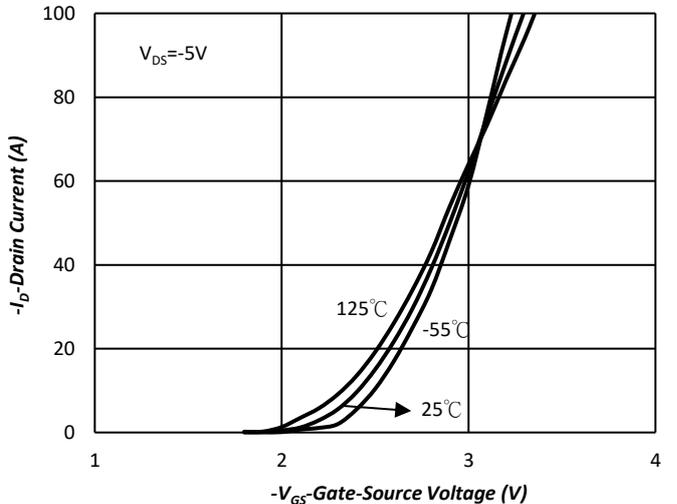
**Fig.3 Normalized On-Resistance v.s. Junction Temperature**



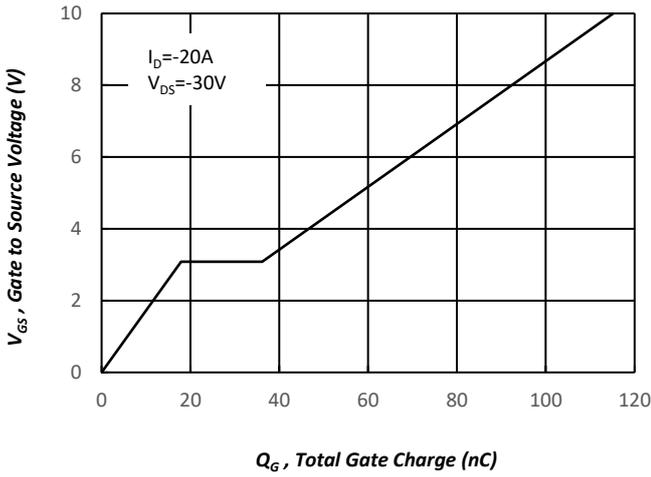
**Fig.4 On-Resistance v.s. Gate Voltage**



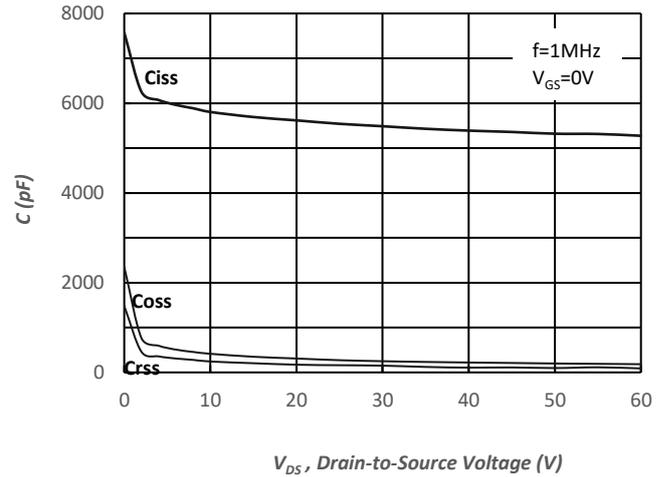
**Fig.5 Forward Characteristic of Reverse Diode**



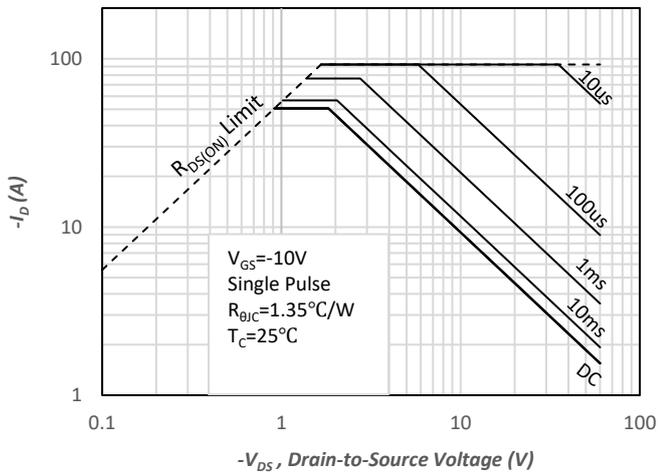
**Fig.6 Transfer Characteristics**



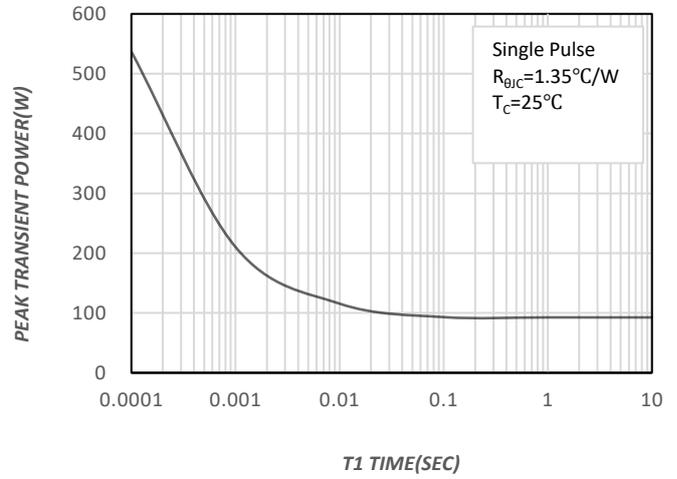
**Fig.7 Gate Charge Characteristics**



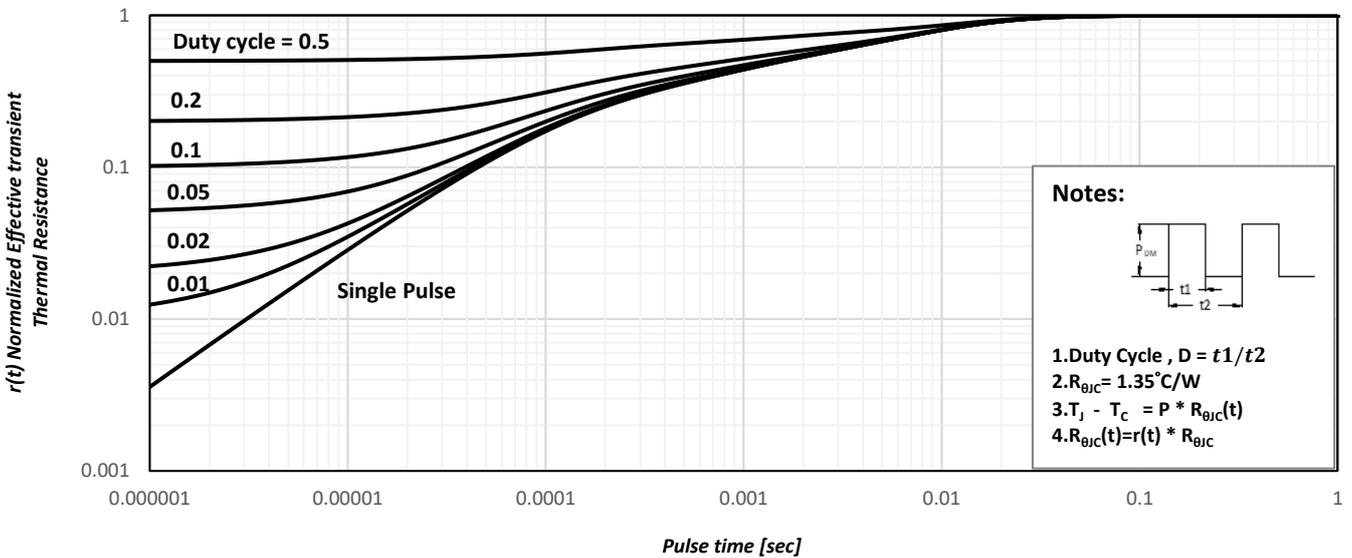
**Fig.8 Typical Capacitance Characteristics**



**Fig.9. Maximum Safe Operating Area**



**Fig.10. Single Pulse Maximum Power Dissipation**



**Fig.11. Effective Transient Thermal Impedance**

**Ordering & Marking Information:**

Device Name:EMB20P06A for TO-252 [DPAK]



B20P06: Device Name

ABCDEFGH: Date Code

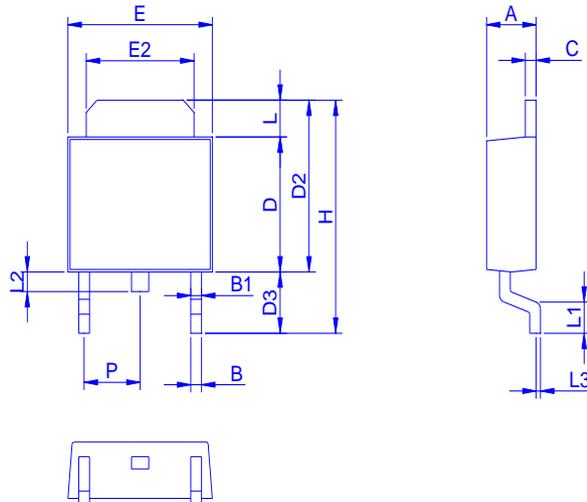
A: Assembly House

B: Year(A:2008 B:2009 C:2010....)

C: Month(A:01 B:02 C:03 D:04 E:05 F:06 G:07 H:08 I:09 J:10 K:11 L:12)

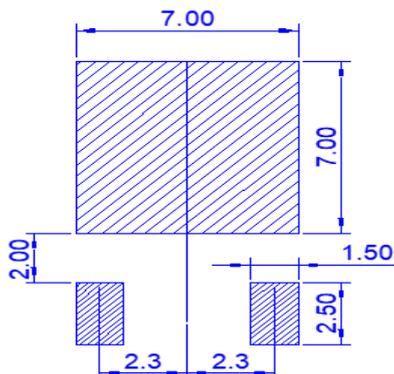
DEFG: Serial No.

**Outline Drawing**

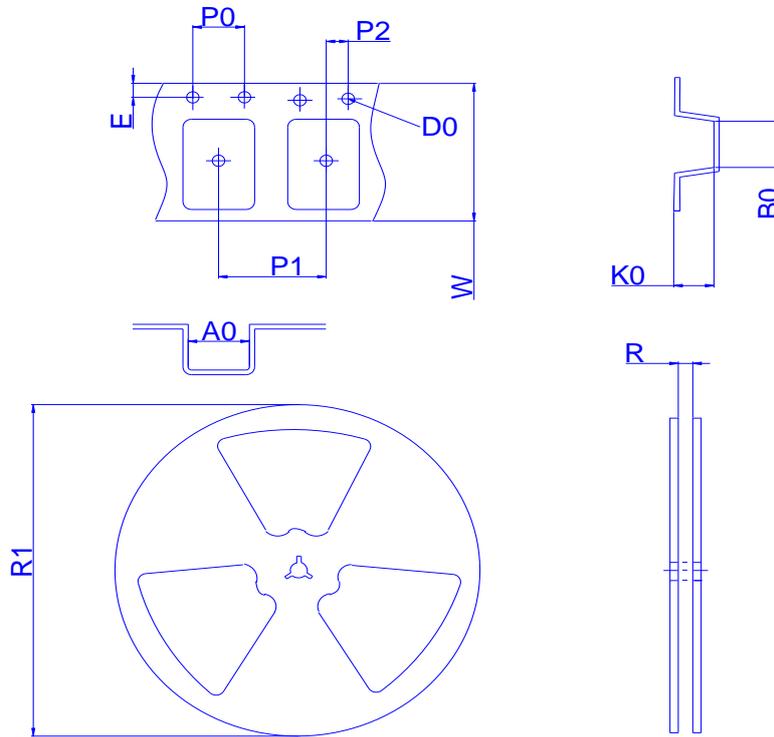


Dimension	A	B	B1	C	D	D2	D3	E	E2	H	L	L1	L2	L3	P
Min	2.1	0.62	0.65	0.45	5.96	6.8	2.6	6.3	4.9	9.3	0.8	1.2	0.5	0	2.1
Typ.	2.25	0.76	0.9	0.67	6.1	7.15	2.8	6.5	5.2	9.9	1.1	1.65	0.8	0.1	2.25
Max	2.4	0.9	1.15	0.89	6.24	7.5	3	6.7	5.5	10.5	1.4	2.1	1.1	0.2	2.4

**Footprint**



◆ Tape&Reel Information:2500pcs/Reel



Package	TO252-2
Reel	13"
Device orientation	<p>FEED DIRECTION</p> <p>→</p>

Dimension in mm

Dimension	Carrier tape									Reel	
	A0	B0	D0	E	K0	P0	P1	P2	W	R	R1
Typ.	6.9	10.5	1.55	1.75	2.7	4	8	2	16	17	330
±	1	1	0.2	0.1	0.2	0.2	0.1	0.1	0.3	2	2